# **MOSFET** – Power, N-Channel, SUPERFET<sup>®</sup> III, FRFET<sup>®</sup>

## **650 V, 65 A, 40 m**Ω

# NTHLD040N65S3HF

#### Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

#### Features

- 700 V @ T<sub>J</sub>= 150°C
- Typ.  $R_{DS(on)} = 32 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ.  $Q_g = 159 \text{ nC}$ )
- Low Effective Output Capacitance (Typ. Coss(eff.) = 1367 pF)
- 100% Avalanche Tested
- . .ues NOT RECONTACTOR MARK • These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### Applications

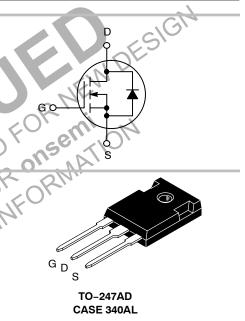
- Telecom / Server Power Supplies
  Industrial Power Supplies
- EV Charger
- UPS / Solar



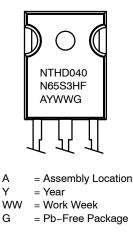
## **ON Semiconductor®**

#### www.onsemi.com

V <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
650 V	40 m $\Omega$ @ 10 V	65 A



#### MARKING DIAGRAM



**ORDERING INFORMATION** 

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit		
V <sub>DSS</sub>	Drain to Source Voltage		650	V	
V <sub>GSS</sub>	Gate to Source Voltage	– DC	±30	V	
		– AC (f > 1 Hz)	±30		
ID	Drain Current	– Continuous (T <sub>C</sub> = 25°C)	65	А	
		– Continuous (T <sub>C</sub> = 100°C)	45		
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	162.5	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		1009	mJ	
I <sub>AS</sub>	Avalanche Current (Note 2)		9	А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		4.46	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		50	4	
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	446	<b>S</b> w	
		- Derate Above 25°C	3.57	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		–55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8	8" from Case for 5 seconds	300	°C	

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality ture. shows be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 9 \text{ A}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ . 3.  $I_{SD} \leq 32.5 \text{ A}$ , di/dt  $\leq 200 \text{ A}/\mu\text{s}$ ,  $V_{DD} \leq 400 \text{ V}$ , starting  $T_J = 25^{\circ}\text{C}$ .

#### **THERMAL CHARACTERISTICS**

0.28	°C/W
40	
N	40

## PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking Package	Packing Method	Reel Size	Tape Width	Quantity
NTHLD040N65S3HF	NTHLD040N65S3HF TO-247	Tube	N/A	N/A	30 Units
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#### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit	
DFF CHARACTERISTICS							
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650			V	
		$V_{GS}$ = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 150°C	700			V	
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 15 \text{ mA}$ , Referenced to $25^{\circ}\text{C}$		0.63		V/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$			10	μΑ	
		$V_{DS} = 520 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		213			
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = $\pm 30$ V, $V_{DS}$ = 0 V			±100	nA	

#### **ON CHARACTERISTICS**

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}$ = $V_{DS}$ , $I_D$ = 2.1 mA	3.0		5.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 32.5 A		32	40	mΩ
9fs	Forward Transconductance	$V_{DS}$ = 20 V, I <sub>D</sub> = 32.5 A		48	10,	S
DYNAMIC CHA	RACTERISTICS				SIG	

#### DYNAMIC CHARACTERISTICS

				-
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz	5945	pF
C <sub>oss</sub>	Output Capacitance		135	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$	1367	pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$	245	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 32.5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	159	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	(Note 4)	46	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	NER UK ORT	64	nC
ESR	Equivalent Series Resistance	f = 1 MHz	1.2	Ω

SWITCHING CHARACTERISTICS

t <sub>d(on)</sub>	Turn-On Delay Time $V_{DD} = 400 V, I_D = 32.5 A,$	40	ns
t <sub>r</sub>	Turn-On Rise Time $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 2,2 \Omega$ (Note 4)	32	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	102	ns
t <sub>f</sub>	Turn-Off Fall Time	26	ns

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SOURCE-DRAIN DIODE CHARACTERISTICS

۱ <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current			65	А
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current			162.5	Α
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 32.5 A		1.3	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{DD} = 400 \text{ V}, I_{SD} = 32.5 \text{ A},$	160		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 A/μs	874		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

### **TYPICAL PERFORMANCE CHARACTERISTICS**

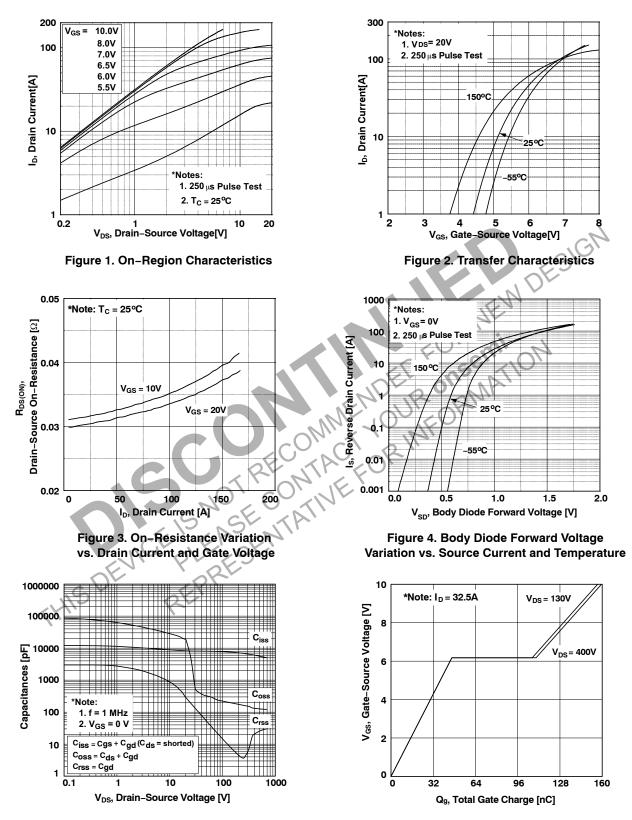


Figure 5. Capacitance Characteristics

Figure 6. Gate Charge Characteristics

### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

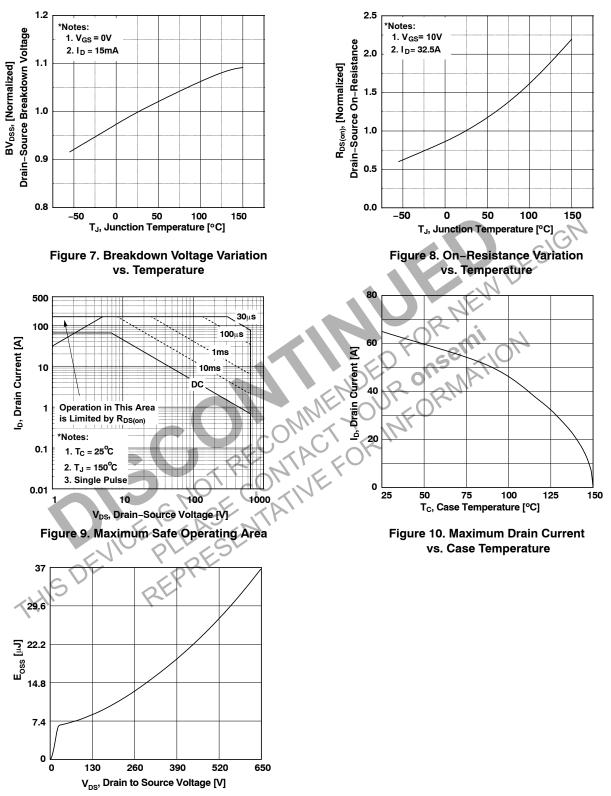
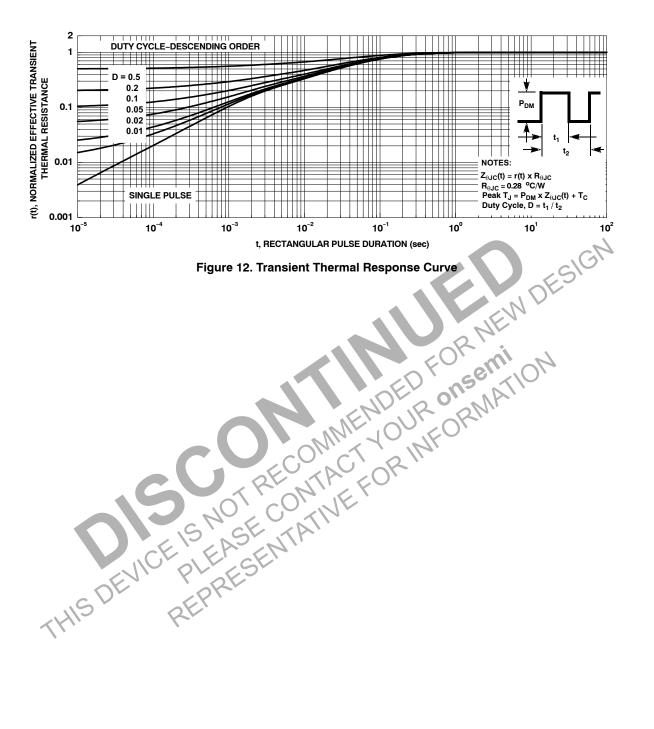
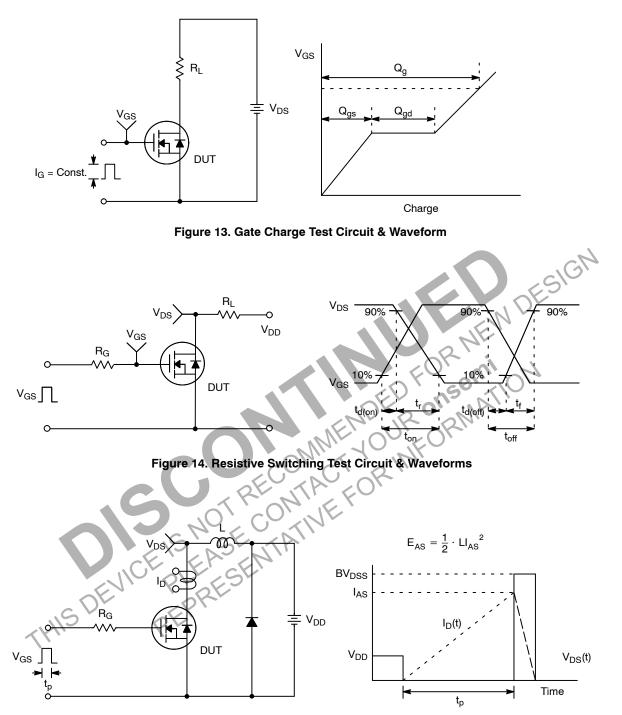


Figure 11. Eoss vs. Drain to Source Voltage

#### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)







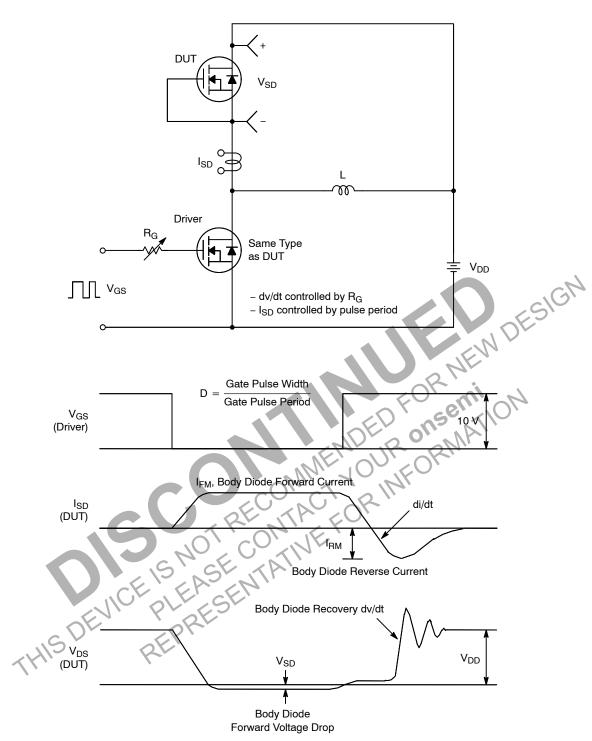


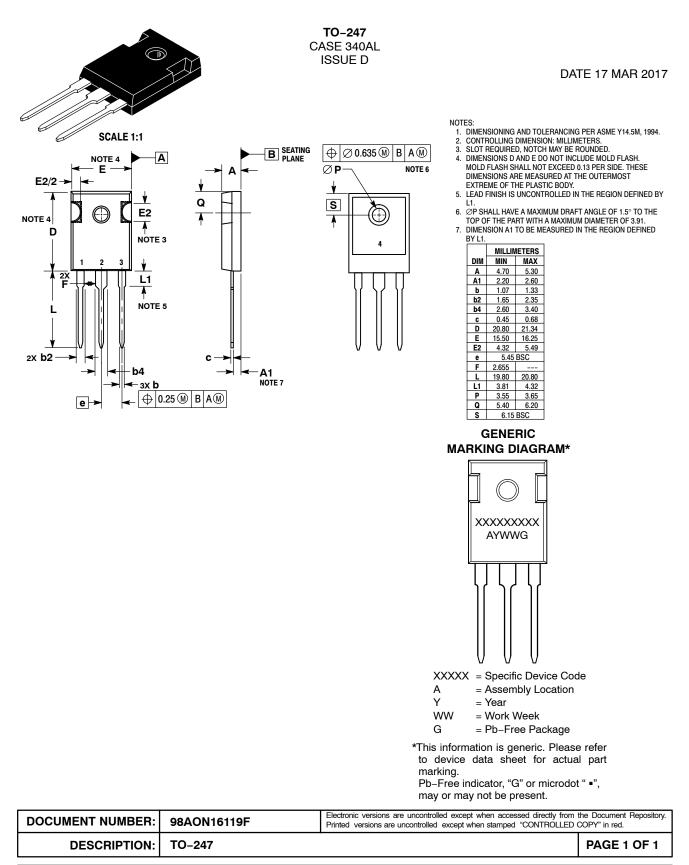
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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## **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS





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